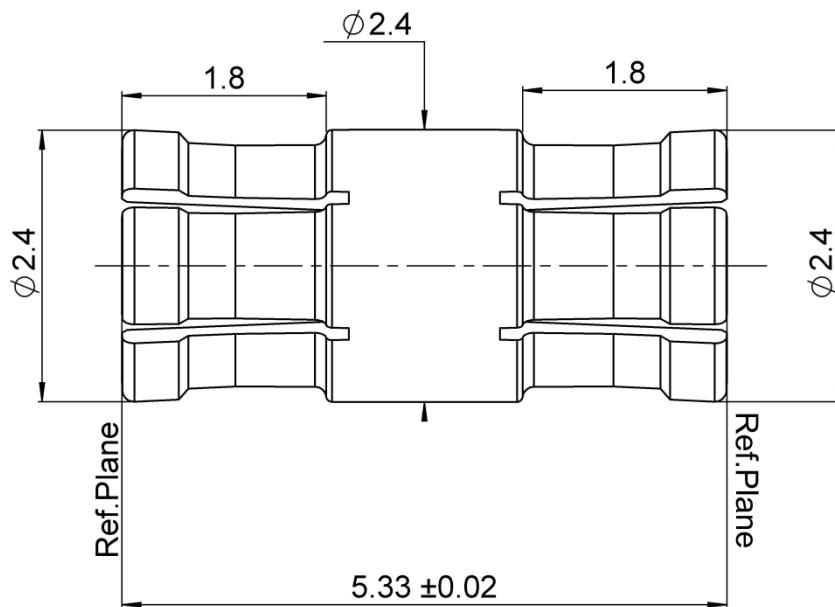
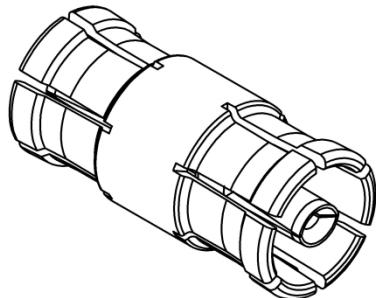


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 SERIES **SMPM**

 PART NUMBER **RS05705000**


 Scale : 1/1


All dimensions are in mm. Tolerances according ISO 2768 m-H



COMPONENTS	MATERIALS	PLATING (μm)
Body	BERYLLIUM COPPER	GOLD OVER NICKEL
Center contact	BERYLLIUM COPPER	GOLD OVER NICKEL
Outer contact		
Insulator	PEEK	
Gasket		
Others parts		
-	-	-
-	-	-

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PACKAGING

Standard	Unit	Other
1	Contact us	Contact us

ELECTRICAL CHARACTERISTICS

Impedance	50	Ω
Frequency	0-65	GHz
VSWR	* + 0,0000	x F(GHz) Maxi
Insertion loss	0.02+0.12	√F(GHz) dB Maxi
RF leakage	- (NA	- F(GHz) dB Maxi
Voltage rating	335	Veff Maxi
Dielectric withstanding voltage	500	Veff mini
Insulation resistance	5000	MΩ mini

ENVIRONMENTAL

Operating temperature	-65/+165	°C
Hermetic seal	NA	Atm.cm ³ /s
Panel leakage	NA	

MECHANICAL CHARACTERISTICS

Center contact retention		
Axial force – Mating End	6.7	N mini
Axial force – Opposite end	6.7	N mini
Torque	NA	N.cm mini
Recommended torque		
Mating	NA	N.cm
Panel nut	NA	N.cm
Mating life	100	Cycles mini
Nominal Weight (Add +15% for max weight)	0,0800	g

SPECIFICATION

RAD-GEN-CONN-006

OTHER CHARACTERISTICS

Assembly instruction:

Others:

***VSWR 1.10 to 12GHz**
VSWR 1.15 12GHz to 26.5GHz
VSWR 1.5 26.5GHz to 40GHz